



Product Change Notification



Product Group: Vishay Siliconix/ June 24, 2019/PCN- SIL-0052019

Manufacturing Capacity Transfer High Voltage MOSFET Die on film and Die on wafer

DESCRIPTION OF CHANGE:

Vishay Siliconix announces the qualification and release to production of manufacturing capacity transfer from Vishay Xi'an factory to Vishay Simconix factory in Shanghai, China for High Voltage MOSFET die sales products in Die-on-film and Die-on-wafer forms.

CLASSIFICATION OF CHANGE: Manufacturing Capacity Transfer

REASON FOR CHANGE: To transfer production capacity on Vishay's High Voltage MOSFET die sales products.

EXPECTED INFLUENCE ON QUALITY/RELIABILITY/PERFORMANCE: There will be no change to product manufacturability, quality, reliability, electrical performance, or footprint. There will be no changes to datasheet performance.

PRODUCT CATEGORY: High Voltage MOSFET products.

PART NUMBERIES/FAMILIES AFFECTED: Please refer to page 2 of this PCN

VISHAY BRAND(s): Vishay-Siliconix

TIME SCHEDULE: Production to begin in Vishay Simconix on die sales product in September 2019.

SAMPLE AVAILABILITY: Samples are available now; please contact your Vishay Regional Marketing or Sales teams to make sample arrangements.

QUALIFICATION DATA: Please contact your local Vishay Sales representative for the qualification report.

Unless specified under Contract or Quality Agreement, this PCN is for notification only. This PCN is considered approved, without further notification, unless we receive specific customer concerns before September 24, 2019 as specified by contract.

ISSUED BY: Michael Hsieh, Vishay Siliconix, Manager, Product Marketing
E-mail address: Michael.hsieh@Vishay.com

For further information, please contact your regional Vishay office.

The Americas
Vishay Americas
2585 Junction Avenue
San Jose, Ca 95134
T: 408-988-8000
F: 408-567-8942

Europe
Vishay Electronic GmbH
Dr.-Felix-Zandman-Platz 1
D-95100
Selb, Germany
T: 49-9287-71 0
F: 49-9287-70435

Asia
Vishay Intertechnology Asia Pte. Ltd
25 Tampines Street 92
#02-00 Keppel Building
Singapore 52887
T: 65-67807838
F: 65-6780-7791

Vishay Intertechnology, Inc.

Corporate Headquarters 63 Lincoln Highway, Malvern, PA 19355-2143 U.S.A. Phone (610) 644-1300 Fax (610) 296-0657 www.vishay.com

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Procedure #



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PCN-SIL- Parts List

Package	Die Sales Part	Package	Die Sales Part	Package	Die Sales Part	Package	Die Sales Part
Die On Film	94-2104	Die On Wafer	IRFC264B	Die On Wafer	IRFC460AB	Die On Wafer	SIHC22N60EDWF
Die On Film	IRFC12N50C	Die On Wafer	IRFC320B	Die On Wafer	IRFC830B	Die On Wafer	SIHFC310DWF
Die On Film	IRFC22N50AC	Die On Wafer	IRFC430BV	Die On Wafer	IRFC840B	Die On Wafer	IRFC730B
Die On Film	IRFC18N50KF	Die On Wafer	IRFC440BV	Die On Wafer	IRFC9024B	Die On Wafer	IRFC634B
Die On Film	IRFC43N50KC	Die On Wafer	IRFC448B	Die On Wafer	IRFCC50B	Die On Wafer	SIHC70N60EFDWF
Die On Film	SIHC47N60SDFFR	Die On Wafer	IRFC9014B	Die On Wafer	IRFC23N50LB	Die On Wafer	SIHC33N60EFDWF
Die On Film	SIHC47N60EDFFR	Die On Wafer	IRFC9034B	Die On Wafer	IRFC32N50KB	Die On Wafer	SIHC28N60EFDWF
Die On Film	SIHC73N60EDFFR	Die On Wafer	IRFC9120B	Die On Wafer	IRFC480LCD	Die On Wafer	SIHC21N60EFDWF
Die On Film	SIHC22N60EDFFR	Die On Wafer	IRFC9240B	Die On Wafer	V961-0006	Die On Wafer	SIHC12N50EDWF
Die On Film	IRFC32N50KC	Die On Wafer	IRFC9630B	Die On Wafer	SIHFC220DWF	Die On Wafer	SIHC15N50EDWF
Die On Film	SIHC01N60DDFFR	Die On Wafer	IRFC9640B	Die On Wafer	SIHFC340DWF	Die On Wafer	SIHC22N60ELDWF
Die On Film	SIHC22N60SDFFR	Die On Wafer	IRFCC40B	Die On Wafer	IRFC460LCB	Die On Wafer	SIHC23N60EDWF
Die On Film	SIHC02N40DDFFR	Die On Wafer	IRFCE20B	Die On Wafer	V961-0004	Die On Wafer	SIHC18N60EDWF
Die On Film	SIHC03N25DDFFR	Die On Wafer	IRFCE30B	Die On Wafer	IRFC234B	Die On Wafer	SIHC12N60EDWF
Die On Film	SIHC460BDDFFR	Die On Wafer	IRFCE40B	Die On Wafer	IRFC31N50LB	Die On Wafer	SIHC15N60EDWF
Die On Film	IRFC460AF	Die On Wafer	IRFCG20B	Die On Wafer	IRFC40N60KB	Die On Wafer	SIHC48N50DWF
Die On Wafer	94-4092	Die On Wafer	IRLC014B	Die On Wafer	IRFC720B	Die On Wafer	SIHC47N60EFDWF
Die On Wafer	IRFC014B	Die On Wafer	IRLC024B	Die On Wafer	IRFCC60B	Die On Wafer	SIHFC48N50DWF
Die On Wafer	IRFC110B	Die On Wafer	IRLC034B	Die On Wafer	SIHFC9130DWF	Die On Wafer	SIHC7N60EDWF
Die On Wafer	IRFC120B	Die On Wafer	IRLC044BV	Die On Wafer	SIHFC9640DWF	Die On Wafer	SIHC64N65EDWF
Die On Wafer	IRFC140B	Die On Wafer	IRLC140B	Die On Wafer	SIHFC9N65ADWF	Die On Wafer	SIHC20N50EDWF
Die On Wafer	IRFC20N50AB	Die On Wafer	IRFCG50B	Die On Wafer	SIHLC640DWF	Die On Wafer	SIHC25N50EDWF
Die On Wafer	IRFC220B	Die On Wafer	IRLC120B	Die On Wafer	SIHC47N60EDWF	Die On Wafer	SIHC6N65EDWF
Die On Wafer	IRFC240B	Die On Wafer	IRFC44RB	Die On Wafer	SIHC47N60SDWF	Die On Wafer	SIHC22N65EDWF
Die On Wafer	IRFC250B	Die On Wafer	IRFC9310B	Die On Wafer	SIHC73N60EDWF	Die On Wafer	SIHC24N65EDWF
Die On Wafer	IRFC2N65AB	Die On Wafer	IRLC130B	Die On Wafer	SIHFC1N60ADWF	Die On Wafer	SIHC33N65EDWF
Die On Wafer	IRFC420B	Die On Wafer	SIHFC30DWF	Die On Wafer	SIHFC20DWF	Die On Wafer	SIHC47N65EDWF
Die On Wafer	IRFC430B	Die On Wafer	IRFC254B	Die On Wafer	SIHFC40DWF	Die On Wafer	SIHC90N65EDWF
Die On Wafer	IRFC440B	Die On Wafer	SIHFC150DWF	Die On Wafer	SIHFC640DWF	Die On Wafer	SIHC61N65EFDWF
Die On Wafer	IRFC4N65AB	Die On Wafer	IRFC130B	Die On Wafer	SIHFC9014DWF	Die On Wafer	IRLC540B
Die On Wafer	IRFC9110B	Die On Wafer	IRFC17N50LB	Die On Wafer	SIHC460BDWF	Die On Wafer	SIHC47N60AEDWF
Die On Wafer	IRFC9130B	Die On Wafer	IRFC214B	Die On Wafer	SIHFCF50DWF	Die On Wafer	SIHC80N60EDWF
Die On Wafer	IRFC9140B	Die On Wafer	IRFC43N50KB	Die On Wafer	SIHFC830ADWF	Die On Wafer	SIHC73N60AEDWF
Die On Wafer	IRFC9220B	Die On Wafer	IRFC450B	Die On Wafer	SIHFC12N50DWF	Die On Wafer	SIHC70N60AEFDWF
Die On Wafer	IRLC110B	Die On Wafer	IRFC110BV	Die On Wafer	SIHC30N60EDWF	Die On Wafer	SIHC47N60AEFDWF
Die On Wafer	IRFC024B	Die On Wafer	IRFC11N50AB	Die On Wafer	IRFC18N50KB	Die On Wafer	64-8000
Die On Wafer	IRFC034B	Die On Wafer	IRFC22N50AB	Die On Wafer	SIHLC630DWF	Die On Wafer	64-9918
Die On Wafer	IRFC054B	Die On Wafer	IRFC350B	Die On Wafer	IRFC840AB	Die On Wafer	64-9946
Die On Wafer	IRFC064B	Die On Wafer	IRFC360B	Die On Wafer	IRFIC9634GB	Die On Wafer	64-9953
Die On Wafer	IRFC1N60AB	Die On Wafer	IRFC37N50AB	Die On Wafer	94-3105	Die On Wafer	64-9955
Die On Wafer	IRFC210B	Die On Wafer	IRFC38N60LB	Die On Wafer	SIHC33N60EDWF	Die On Wafer	64-9956
Die On Wafer	IRFC210BV	Die On Wafer	IRFC40N50LB	Die On Wafer	IRFC9214B		
Die On Wafer	IRFC220BV	Die On Wafer	IRFC420AB	Die On Wafer	SIHC460B		
Die On Wafer	IRFC240BV	Die On Wafer	IRFC430AB	Die On Wafer	IRFC230B		
Die On Wafer	IRFC260B	Die On Wafer	IRFC450BV	Die On Wafer	SIHFC10N40DDWF		

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Corporate Headquarters 63 Lincoln Highway, Malvern, PA 19355-2143 U.S.A. Phone (610) 644-1300 Fax (610) 296-0657 www.vishay.com

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